

Title (en)

METHOD FOR PRODUCING SEAMLESS PIPE

Title (de)

VERFAHREN ZUR HERSTELLUNG EINES NAHTLOSEN ROHRS

Title (fr)

PROCÉDÉ DE FABRICATION D'UN TUBE SANS SOUDURE

Publication

**EP 2281641 A4 20131002 (EN)**

Application

**EP 09723678 A 20090227**

Priority

- JP 2009053652 W 20090227
- JP 2008082734 A 20080327

Abstract (en)

[origin: EP2281641A1] Disclosed is a method for producing a seamless pipe by using a piercing mill which pierces and rolls a round billet heated to 1300 °C or lower, wherein the piercing mill is composed of a pair of skew rolls disposed to face each other across a pass line, a pair of guide devices disposed to face each other across the pass line, and a plug disposed along the pass line, between the pair of the skew rolls and also between the pair of the guide devices, wherein the piercing-rolling is performed under the conditions satisfying the following formulas (1) to (3) to prevent wrinkle flaws of the seamless pipe:  $-1.0 < \frac{r}{p} = \frac{p}{r} - \frac{0.37}{n} + 1.47 \leq R_n \leq 0.37 \times \frac{r}{p} + 2.67$  wherein the meanings of the individual symbols in the above-described formulas are as follows:  $r$ : The half angle ( $^{\circ}$ ) between the pass line and the main roll face in the condition of the feed angle of the main rolls being zero,  $p$ : The half angle ( $^{\circ}$ ) between the pass line and the reeling section of the plug,  $R_n$ : The number of times of the reeling of the plug

IPC 8 full level

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CPC (source: EP US)

**B21B 19/04** (2013.01 - EP US); **B21B 25/00** (2013.01 - EP US); **B21B 27/025** (2013.01 - EP US)

Citation (search report)

- [XI] EP 1593441 A1 20051109 - SUMITOMO METAL IND [JP]
- See references of WO 2009119245A1

Designated contracting state (EPC)

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